



Figure only indicative

# SolidStateMC 5 field

Intended for Part numbers as listed in Table 1



**Technical Manual** 



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### 1. Introduction

#### 1.1. Contact information

This manual provides all the technical information necessary for the correct installation, application and maintenance of the SolidStateMC.

If you need additional information, need support or want to report a problem with the device, please contact your distributor or Varex Imaging Nederland B.V.:

	Manufacturer	Distributor
Name	Varex Imaging Nederland B.V.	
Address	Fabriekstraat 41, 7005 AP Doetinchem The Netherlands	
Telephone	+31 (0)314 799 870	
E-mail	Netherlands.CNC@vareximaging.com	
Website	www.vareximaging.com	

For support and service purposes, please copy the following information from the product label:

Model name:	
Part number:	
Serial number:	

### 1.2. Declaration of Conformance

Varex Imaging Nederland B.V. hereby declares that this product is in conformity with the essential requirements and provisions as set forth in European Union Council Directive 93/42/EEC concerning medical devices (revision 2007-09-27). See the included Declaration document.

### 1.3. Symbols used in this document

To ensure adequate and clear understanding of the information provided in this manual, the symbols listed below are used to indicate warnings, cautions, actions and notes that are important for correct and safe use of the device.



#### WARNING:

Warnings are directions which, if they are not followed, can cause fatal or serious injuries to a user, engineer, patient or any other person or can lead to a mistreatment.



#### **CAUTION:**

Cautions are directions which, if they are not followed, can cause damage to the device described in this manual or any other equipment or goods and can cause environmental pollution.



#### NOTE

Notes provide advice and highlight unusual points. A note is not intended as an instruction.



### 1.4. Abbreviations

Term	Definition					
AEC	Automatic Exposure Control					
Al	Aluminum					
CE	Conformité Européenne					
CISPR	Comité International Spécial de Perturbations Radioélectriques					
EMC	Electromagnetic compatibility					
ESD	Electro Static Discharge					
HVL	Half Value Layer					
IEC	International Electrotechnical Commission					
ME	Medical Equipment					
MOPP	Means of Patient Protection					
N.A.	Non-applicable					

This document contains terminology and definitions based on (international) standards. The terminology and definitions are formatted in capital letters (e.g. INTENDED USE). Terminology and definitions from the following standards are used:

Reference	Title
IEC 60601-1	Medical electrical equipment – Part 1: General requirements for basic safety and essential performance
IEC 60601-1-2	Medical electrical equipment – Part 1-2: General requirements for basic safety and essential performance – Collateral Standard: Electromagnetic disturbances – Requirements and tests
IEC 60601-1-3	Medical electrical equipment – Part 1-3: General requirements for basic safety and essential performance – Collateral Standard: Radiation protection in diagnostic X-ray equipment
IEC 60601-2-54	Medical electrical equipment – Part 2-54: Particular requirements for the basic safety and essential performance of X-ray equipment for radiography and radioscopy

# 1.5. General warnings, cautions and notes

<u> </u>	WARNING: To avoid the risk of electric shock, this equipment must only be connected to a system insulated from supply mains according to IEC-60601-1.
	WARNING: The SolidStateMC is a delicate device and needs to be handled with care.
<u>^</u>	WARNING: Do not modify this equipment without authorization of the manufacturer. This includes drilling holes.
<u> </u>	WARNING: The device contains sensitive electronics. Ensure that ESD protective measures are in place when the device is installed or serviced to prevent damage to the device.



### 1.6. Supplied components

The device is packed in a package appropriately designed to ensure the integrity of the device. Please ensure that the contents of the package you received is intact and that there are no traces of moisture or visual damages. Otherwise, you should immediately contact your distributor or Varex Imaging Nederland B.V..

The package contains the following components:

Amount	Description	Reference		
1	AmpMC	For Model and Part number see the product label on the AmpMC		
1*	Documentation	Technical Manual TM20779-10 and Declaration of Conformity (CE)		
1*	IFU card	Instruction for electronic download of documentation via Varex website		

<sup>\*)</sup> One of these items must be supplied in the package

#### 1.7. Accessories

The following accessories can be ordered separately.

Description	Purpose						
Extension cables, for use between SolidStateMo	C and AmpMC						
Extension cable, SSMC, 12 pin, 15m	To connect all 5 field SolidStateMC models to AmpMC						
Extension cable, SSMC, 12 pin, 20m	model 1007 + 1012.						
Extension cable, SSMC, 12 pin, 25m							
AmpMC models for 5 field SolidStateMC models, voltage ramp output							
AmpMC 1007, 5-field integrating amplifier	D out 15 pin Mole						
AmpMC 1012, 5-field integrating amplifier	D-sub 15-pin Male						



# 2. Product description

#### 2.1. Intended use

The SolidStateMC is intended to be used in medical diagnostic applications with restrictions to human diagnostics. The device is intended to be used as accessory of an X-ray system in a professional healthcare facility environment. The device is intended to measure the intensity of the X-ray beam before entering the imaging receptor (e.g. film, detector). The restrictions on use are specified in §2.5. The device is not intended to be used in fluoroscopy applications; near active HF Surgical Equipment or in the RF shielded room of a system for magnetic resonance imaging, where the intensity of Electromagnetic Disturbances is high.

Use, other than above, is identified as abnormal use.

The device is intended as an internal component of an X-ray system. The intended user is defined as the Service Personnel of an X-ray system.

### 2.2. Description of the device

The SolidStateMC is intended be used for measuring X-ray radiation in a Radiography X-ray system. The SolidStateMC must be placed between a patient and an imaging receptor (e.g. film, detector) to generate a signal that is used by an automatic exposure control unit to establish optimized exposure parameters to a patient.

### 2.3. Principle of operation

The SolidStateMC as described in this document, is to generate a real time electrical signal equivalent to the X-ray dose rate for medical radiology. This signal is generated by X-ray sensitive photodiodes.

#### 2.4. Classifications

Subject	Classification	Reference					
CE	IIB	93/42/EEC					
Electrical safety	None	IEC 60601-1					
Electromagnetic Compatibility intended environment	Professional healthcare facility environment	IEC 60601-1-2					
Mode of operation	Continuous	IEC 60601-1					
Ingress protection	IP2X	IEC 60529					
Protection	1 MOPP @ 43VDC	IEC 60601-1					
Not intended for use in Oxygen Rich environment.							
Not suitable for Sterilization.							

#### 2.5. Restrictions on use

The SolidStateMC can only be used in combination with an Amplifier in a Radiography X-ray system that complies with the IEC 60601-1 standard applicable at date of manufacture.

The SolidStateMC is intended to be installed inside a cassette holder (Bucky system) of the X-ray system. Depending on final assembly, additional EMC measures may need to be taken.

The relevant restrictions for the X-ray system continue to apply (see the documentation of the X-ray system). The SolidStateMC does not add new restrictions on top of these.



#### WARNING:

The measured X-ray dose by the SolidStateMC is an input for Automatic Exposure Control (AEC). Care must be taken with patients who bear non body-own objects like metal implants, which may excessively absorb X-rays. As these objects may lie between the X-ray source and the sensing field of the SolidStateMC, the signal to the AEC may be weakened, thus increasing the risk of overexposure.



### 2.6. Contraindications

The relevant contraindications for the X-ray system continue to apply (see the documentation for the X-ray system). The SolidStateMC does not add new contraindications on top of these.

#### 2.7. Overview of the device

Table 1 SolidStateMC specifications

		Dimensions (			ns (r	ıs (mm)					
lel	Cover material		Outs	ide			age ea	<b>.</b> ∈	Cable	Sensitivity X10 <sup>-9</sup> A/µGy/s	
Model	Cover materi	w	L	Т	Тс	Wi	Li	Cable Length	Exit	Sensif X10-9 /	Remarks
508	С	472	460	3	6.5	442	434	300	Left bottom	1.2	See Figure 4
521		500	397			431	355		Top right		See Figure 5
										Field se	ensitivity (all fields)
									Exit point of cable		
								Cable le	ength including connector		
							Leng	th of ima	aging area		
			Width of imaging area								
			Thickness of SolidStateMC at cable exit side								
				Thi	ckness of SolidStateMC at imaging area						
			Length of SolidStateMC								
		Width of SolidStateMC									
	C= Ca	rbon									

# 2.8. Specifications

Description	Reference					
kV range	40 to 150kV					
X-ray attenuation. 99.9 % Al purity.	Carbon < 0.9mm. at 70-90 kV and HVL 2.5-3.2 Al					
Dose rate	20 μGy/s to 5000 μGy/s					
Reproducibility	0.02 Coefficient of variation					
Relative kV sensitivity	40 kV 1.12 50 kV 1.11 60 kV 1.08 80 kV 1.00 100 kV 0.94 120 kV 0.86 140 kV 0.80					
Reaction Time	≤ 1.6 ms.					
Sensitivity Tolerance	± 25% max. Between fields ±10% maximum difference.					
Materials	Carbon					
Application	Use as sensor in AEC circuits					
Weight	< 1.3 kg					
Operation environment	Ambient temperature: +10°C to +40°C Relative humidity: 35% to 85% non-condensing Atm. Pressure: 860hPa to 1060hPa					
Storage / Transport	Ambient temperature: -20°C to +60°C Relative humidity: 35% to 85% non-condensing Atm. Pressure: 860hPa to 1060hPa					
Acceleration / Shock	Maximum 10 G allowed from external conditions (e.g. during transport)					

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Description	Reference
Applicable standards	IEC60601-1 IEC60601-1-2 IEC60601-1-3 IEC60601-2-54

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Revision: 6.0B Date of release: 2020-08-04



### 3. Installation



#### NOTE:

Allow the system to level with room temperature before installation.

### 3.1. Installation requirements



#### **WARNING:**

Installation and initial operation may only be carried out by an expert who has been trained in the field of medical diagnostic X-ray equipment.



#### WARNING:

Modifications to the product are not allowed.



#### WARNING:

Do not soak the device with liquids.

#### 3.2. Installation instructions

In the X-ray path, the position of the SolidStateMC is always between patient and image receptor. In case an anti-scatter grid is mounted, the SolidStateMC is installed between the anti-scatter grid and the image receptor.

Position the SolidStateMC in such a way that the centre aligns with the centre of the X-ray beam. The imprint on the SolidStateMC must be facing the X-ray tube.

Mechanical mounting must be done in such a way that the structural integrity is maintained.

Connect the SolidStateMC to the control electronics by means of a cable, see chapter 1.7. The Connection diagram and plug pin layout of this cable are found under chapter 5.2.1.

Correct functioning of the SolidStateMC is guaranteed only if the cable as well as the SolidStateMC shielding is properly connected.

Setting the sensitivity must be done by following the AEC check procedure of the X-ray system.

### 3.3. Necessary recurrent testing



#### **WARNING:**

Before granting the automatic exposure control for the use on patients, check the functionality of all AEC fields with a phantom.

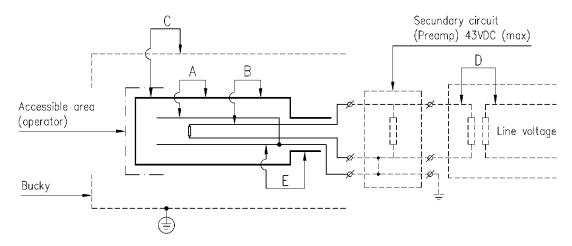
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### 4. Mains isolation

The SolidStateMC always needs to be connected to a host system that complies with the required regulations and standards.



Ref.	Insulation	Working voltage	Insulation test voltage
Α	1 MOPP	43 VDC	500 VACrms
В	1 MOPP	43 VDC	500 VACrms
С	1 MOPP	43 VDC	See note 1
D	2 MOPP	Line Voltage	See note 1
Ε	1 MOPP	43 VDC	500 VACrms

Note 1: Out of product scope,

Figure 1 Means of protection

# 5. Service, maintenance and cleaning

Refer service to a qualified service technician only.

A SolidStateMC does not require any maintenance and will last during the lifetime of the X-ray system. In case of malfunction of the AEC system, the SolidStateMC can be checked according to the described test procedure in chapter 5.5.

### 5.1. Safety precautions

When there is structural damage to the housing or cable of the device, label the device as "out of order" and have the device repaired prior to further use.

#### 5.1.1. Procedure at defects

- Exchange extension cable.
- Exchange SolidStateMC



### 5.2. Device Data

### 5.2.1. Connections

#### Plug pin layout

Type of plug: BINDER® Series 680
circular 12 pins connector, male.

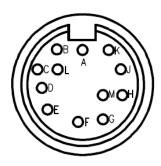


Figure 2, Connector layout solder side view

in ID	Color	Function
Α	-	Not connected
B	White	Field 1 - anode
C	Brown	Field 1 - cathode
D	Green	Field 3 - anode
E	Yellow	Field 3 - cathode
F	Grey	Field 2 - cathode
G	Pink	Field 2 - anode
H	Blue	Field 4 - anode
J	Red	Field 4 - cathode
K	Black	Field 5 - anode
L	Violet	Field 5 - cathode
М		Not connected

### 5.2.2. Equivalent schematic

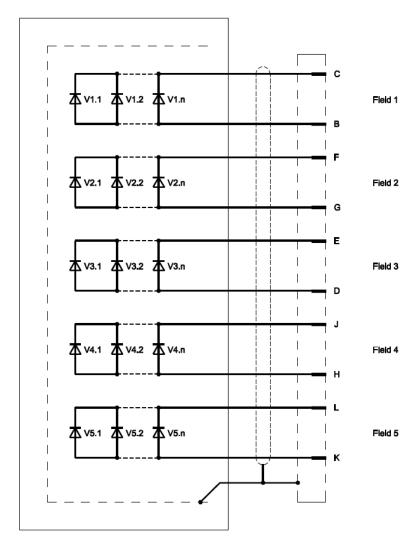
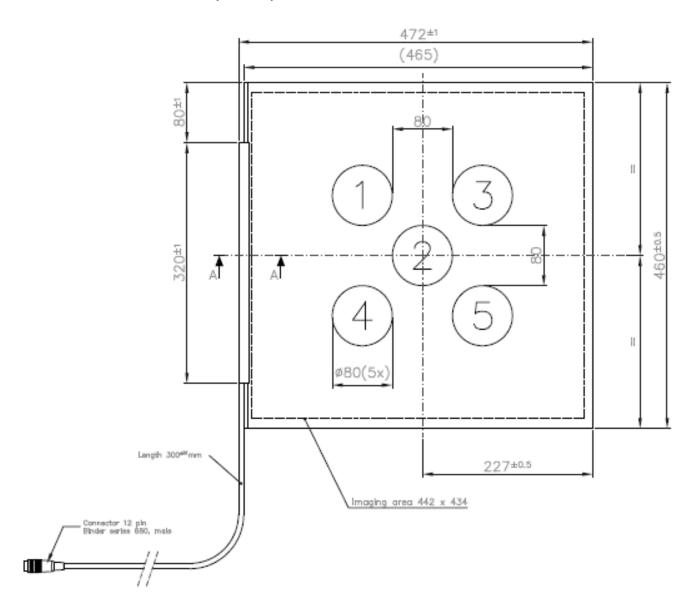


Figure 3 Equivalent Schematic



## 5.2.3. Dimensions (in mm) for SolidStateMC 508



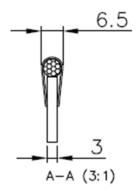
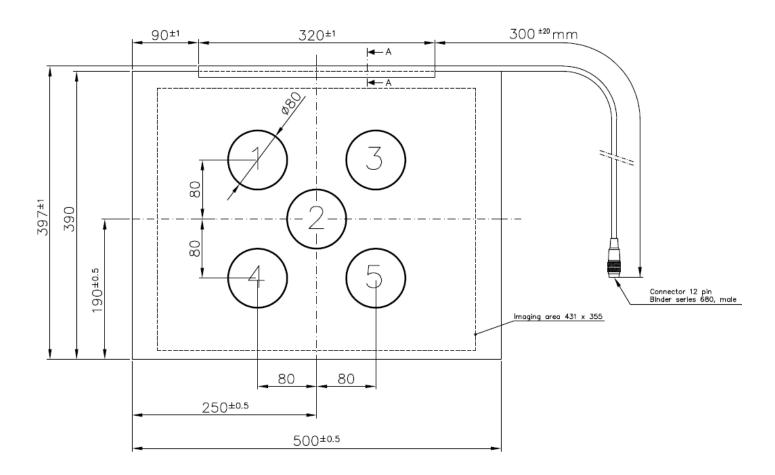


Figure 4 Mechanical Layout SolidStateMC 508

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## 5.2.4. Dimensions (in mm) for SolidStateMC 521



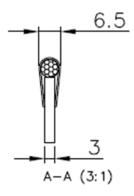


Figure 5 Mechanical Layout SolidStateMC 521



### 5.3. Cleaning

Cleaning with a damp cloth is recommended. Use generally available alcohol-based cleaning agents.

#### 5.4. Disinfection

Disinfection with a damp cloth with Isopropyl alcohol is recommended. Before using a disinfectant, check at a spot on the bottom of the device if the disinfectant will not damage the plastic and coated metal surfaces.

#### 5.5. Test Procedure

#### 5.5.1. Check-up on open contacts or short circuits

Check-up of the SolidStateMC and (extension) cable is done with a digital multi-meter, check for open contacts and short circuits.

The terminal arrangement is found in the schematic diagram, and connector pin layout 5.2.1. Locate possible defects at SolidStateMC or extension cable by checking on the connector or, if applicable, on the connector at the electronic side of the extension cable.

#### 5.5.2. Auxiliary measurement under radiation

Perform a separate measurement for each field of the SolidStateMC. Cover the SolidStateMC with shielding material except the field to be measured or limit the X-ray beam with a collimator to the measured field only.

The measurement is carried out as a voltage measurement.

Connect voltmeter (anode on +, cathode on -) and apply a load-resistance of 47K ohm.

#### Rejection limit:

If - under the same conditions – the measured voltage differ more than 30% from the recorded reference values, replace the SolidStateMC.

#### Typical value

The measured voltage depends on several factors. The following indication serves as typical value:

Tube voltage 40 kV
Tube current 100 mA
Distance focal spot –SolidStateMC 150 cm
HVL 1.8

Under these conditions the typical auxiliary voltage on the SolidStateMC is approximately the sensitivity value from Table 1 multiplied by 20 and expressed in mV.

# 6. Quality Assurance (QA)

A SolidStateMC is part of the X-ray systems performance requirements and the adjustment procedures for the complete X-ray system are mandatory.

There are no additional QA procedures for using the SolidStateMC.



# 7. Disposal, ESD and EMC compatibility

### 7.1. Disposal

This device contains substances that can be hazardous to the environment and care should be taken when disposed of.

The device is marked with the following symbol:

Follow local regulations regarding disposal of devices that contain electronic parts.

#### 7.2. ESD



#### **WARNING:**

The device contains sensitive electronics. Ensure that ESD protective measures are in place when the device is installed or serviced to prevent damage to the device.

### 7.3. EMC compatibility

The device conforms to IEC 60601-1-2:2014 for EMC compatibility and must be installed and put into service according to the EMC information provided in this manual.

#### **WARNING:**

Portable RF communications equipment (including peripherals such as antenna cables and external antennas) should be used no closer than 30 cm (12 inches) to any part of the SolidStateMC 5 field, including cables specified by the manufacturer. Otherwise, degradation of the performance of this equipment could result.



#### **WARNING:**

Not taking EMC measures into account on the wiring may result in increased EMISSIONS or decreased IMMUNITY. IEC 60601-1-2:2014 must be followed for being complaint with EMC guidelines.



#### **WARNING:**

Use of this equipment adjacent to or stacked with other equipment should be avoided because it could result in improper operation. If such use is necessary, this equipment and the other equipment should be observed to verify that they are operating normally.



#### **WARNING:**

Use of accessories, transducers and cables other than those specified or provided by the manufacturer of this equipment could result in increased electromagnetic emissions or decreased electromagnetic immunity of this equipment and result in improper operation.





The EMISSIONS characteristics of this equipment make it suitable for use in industrial areas and hospitals (CISPR 11 class A). If it is used in a residential environment (for which CISPR 11 class B is normally required) this equipment might not offer adequate protection to radio-frequency communication services. The user might need to take mitigation measures, such as relocating or re-orienting the equipment.

#### 7.3.1. Deviations

No deviations from IEC60601-1-2:2014 are applied.

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#### 7.3.2. Allowances

No allowances from IEC60601-1-2:2014 are used.

### 7.3.3. Precautions

Precautions to be taken to prevent adverse events to the PATIENT and the OPERATOR due to Electromagnetic disturbances are listed in the column "Electromagnetic environment – guidance" in the tables below.

### 7.3.4. Emissions Compliance

	Guidance and manufacturer's o	declaration – Electromagnetic emissions
	eld is intended for use in the Electro Id should assure that it is used in su	magnetic environment specified below. The customer or user of uch an environment.
Emissions test	Compliance	Electromagnetic environment - guidance
RF emissions group CISPR 11	Group 1	The SolidStateMC 5 field uses RF energy only for its internal function. Therefore, its RF emissions are very low and are not likely to cause any interference in nearby electronic equipment.
RF emissions class CISPR 11	Class A	The EMISSIONS characteristics of SolidStateMC 5 field make it suitable for use in industrial areas and hospitals (CISPR 11 class
Harmonic emissions IEC 61000-3-2	Not Applicable	A). If it is used in a residential environment (for which CISPR 11 class B is normally required) this equipment might not offer adequate protection to radio-frequency communication services.
Voltage fluctuations/ flicker emissions IEC 61000-3-3	Not Applicable	The user might need to take mitigation measures, such as relocating or re-orienting the equipment."

## 7.3.5. Immunity Compliance

Guidance and manufacturer's declaration – Electromagnetic immunity – ENCLOSURE PORT		
The SolidStateMC 5 field is intended for use in the electromagnetic environment specified below. The customer or user of the SolidStateMC 5 field should assure that it is used in such an environment.		
Immunity test	Compliance Test level	Electromagnetic environment - guidance
Electrostatic discharge (ESD) IEC 61000-4-2	± 8 kV contact ± 2 kV, ± 4 kV, ± 8 kV, ± 15 kV air	Floors should be wood, concrete or ceramic tile. If floors are covered with synthetic material, the relative humidity should be at least 30 %.
Proximity fields from RF wireless communications equipment IEC 61000-4-3	See next table below	Portable RF communications equipment (including peripherals such as antenna cables and external antennas) should be used no closer than 30 cm (12 inches)
Power frequency (50/60 Hz) magnetic field IEC 61000-4-8	Not Applicable	Power frequency magnetic fields should be at levels characteristic of a typical location in a typical commercial or hospital environment.

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#### Guidance and manufacturer's declaration – electromagnetic immunity – Compliance Test Levels for ENCLOSURE PORT IMMUNITY to RF wireless communications equipment

Test frequency (MHz)	Band (MHz)	Service <sup>a)</sup>	Modulation	Maximum power (W)	Distance (m)	IMMUNITY TEST LEVEL (V/m)
385	380 – 390	TETRA 400	Pulse modulation b)	1,8	0,3	27
450	430 – 470	GMRS 460; FRS 460	FM ± 5 kHz deviation 1 kHz sine	2	0,3	28
710			Pulse Modulation b)			
745	704 – 787	LTE Band 13, 17	Pulse Modulation <sup>5</sup>	0,2	0,3	9
780			217 Hz			
810		GMS 800/900; TETRA 800;	Dula - Madulation b)			
870	800 – 960	iDEN 820;	Pulse Modulation b)	2	0,3	28
930		CDMA 850; LTE Band 5	18 Hz			
1 720		GSM 1800; CDMA 1900;	Deda - Madedation b)			
1 845	1 700 – 1	GSM 1900;	Pulse Modulation b)	2	0,3	28
1 970	990	DECT; LTE Band 1, 3, 4, 25; UMTS	217 Hz	2	3,3	
2 450	2 400 – 2 570	Bluetooth; WLAN 802.11 b/g/n; RFID 2450;	Pulse Modulation b)	2	0,3	28
		LTE Band 7	217 Hz			
5 240			Pulse Modulation b)			
5 500	5 100 – 5 800	WLAN 802.11 a/n		0,2	0,3	9
5 785			217 Hz		1	

a) For some services, only the uplink frequencies are included.
 b) The carrier is modulated using a 50 % duty cycle square wave signal.



#### Guidance and manufacturer's declaration - Electromagnetic immunity - POWER and Signal PORTS

The SolidStateMC 5 field is intended for use in the Electromagnetic environment specified below. The customer or user of the SolidStateMC 5 field should assure that it is used in such an environment.

Immunity test	Compliance Test level	Electromagnetic environment - guidance
Electrostatic discharge (ESD) IEC 61000-4-2	± 8 kV contact ± 2 kV, ± 4 kV, ± 8 kV, ± 15 kV air	Floors should be wood, concrete or ceramic tile. If floors are covered with synthetic material, the relative humidity should be at least 30 %.
Electrical fast transient/burst IEC 61000-4-4	± 2 kV AC and DC power ports ± 1 kV signal ports 100kHz repetition frequency	Mains power quality should be that of a typical commercial or hospital environment.
Surges	Not Applicable	The SolidStateMC 5 field is intended to be supplied by a secondary
Line-to-line IEC 61000-4-5		IEC60601-1 compliant AC or DC power supply.
Surges	Not Applicable	
Line-to-ground IEC 61000-4-5		
Conducted	3 V a)	Field strengths from fixed RF transmitters, as determined by an
disturbances induced by RF fields	0,15 MHz – 80 Mhz	electromagnetic site survey c, should be less than the compliance level in each frequency range.
IEC 61000-4-6	6 V <sup>a)</sup> in ISM bands between 0,15 MHz and 80 MHz <sup>b)</sup>	Interference may occur near equipment marked with the following symbol:
	80 % AM at 1 kHz	
Voltage dips IEC 61000-4-11	Not Applicable	The SolidStateMC 5 field is intended to be supplied by a secondary IEC60601-1 compliant AC or DC power supply.
Voltage interruptions IEC 61000-4-11	Not Applicable	

a) r.m.s. before modulation is applied

#### NOTE

These guidelines may not apply in all situations. Electromagnetic propagation is affected by absorption and reflection from structures, objects and people

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<sup>&</sup>lt;sup>b)</sup> The ISM (industrial, scientific and medical) bands between 150 kHz and 80 MHz are 6,765 MHz to 6,795 MHz; 13,553 MHz to 13,567 MHz; 26,957 MHz to 27,283 MHz; and 40,66 MHz to 40,70 MHz. The amateur radio bands between 0,15 MHz and 80 MHz are 1,8 MHz to 2,0 MHz, 3,5 MHz to 4,0 MHz, 5,3 MHz to 5,4 MHz, 7 MHz to 7,3 MHz, 10,1 MHz to 10,15 MHz, 14 MHz to 14,2 MHz, 18,07 MHz to 18,17 MHz, 21,0 MHz to 21,4 MHz, 24,89 MHz to 24,99 MHz, 28,0 MHz to 29,7 MHz and 50,0 MHz to 54,0 MHz.

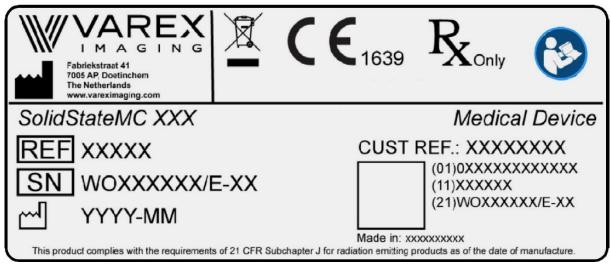
c) Field strengths from fixed transmitters, such as base stations for radio (cellular/cordless) telephones and land mobile radios, amateur radio, AM and FM radio broadcast and TV broadcast cannot be predicted theoretically with accuracy. To assess the electromagnetic environment due to fixed RF transmitters, an electromagnetic site survey should be considered. If the measured field strength in the location in which the SolidStateMC 5 field is used exceeds the applicable RF compliance level above, the SolidStateMC 5 field should be observed to verify normal operation. If abnormal performance is observed, additional measures may be necessary, such as re-orienting or relocating the SolidStateMC 5 field.



# 8. Product label and symbols on the device

#### 8.1. Product label

The product label can be found at the lower right-hand side of the SolidStateMC.



### 8.2. Symbols on the device

Symbol	Explanation
	Manufacturer.
$\sim$	Date of manufacture.
REF	Catalogue number.
SN	Serial number.
<b>C E</b> <sub>1639</sub>	CE-mark directive 93/42/EC; conformity assessment by notified body 1639.
<b>③</b>	Follow the instructions for use.  Reading the instructions for use is mandatory for a correct and safe operation of the SolidStateMC.
<u> </u>	Identification of compliance with the provisions for EU WEEE directive.
$ m R_{ ext{\tiny Only}}$	For professional use only
FC	Identification of compliance with FCC 47 CFR Part 15 (optional feature)



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